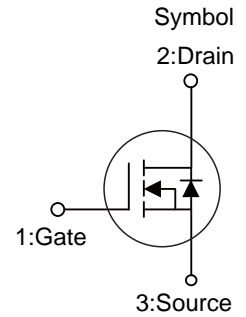


■ PRODUCT CHARACTERISTICS

V _{DSS}	650V
R _{DS(ON)} Typ(@V _{GS} =10V)	0.27Ω
Q _g @typ	22nC
I _D	15A

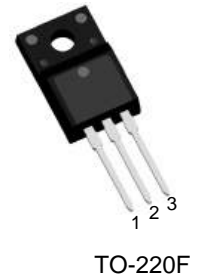


■ APPLICATIONS

- * High efficiency switch mode power supplies
- * Electronic lamp ballasts based on half bridge
- * LED power supplies

■ FEATURE

- * High Switching Speed
- * Improved dv/dt capability



■ ORDER INFORMATION

Order Codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT65R280F	TO-220F	50 pieces/Tube

■ ABSOLUTE MAXIMUM RATINGS(T_A=25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V _{DSS}	650	V
Gate-Source Voltage	V _{GSS}	±30	V
Drain Current Continuous(@V _{GS} =10V, T _A =25°C)	I _D	15	A
Drain Current Pulsed	I _{DM}	60	A
Avalanche Energy *	E _{AS}	180	mJ
Peak Diode Recovery dv/dt	dv/dt	5.0	V/ns
Power Dissipation	P _D	39	W
Junction Temperature	T _J	+150	°C
Storage Temperature	T _{STG}	-55~ +150	°C

■ THERMAL CHARACTERISTICS

Parameter	Symbol	Typ	Unit
Junction to Ambient	R _{thJA}	62.5	°C/W
Junction to Case	R _{thJC}	3.2	°C/W

Note: * EAS condition: T_J=25°C, V_{DD}=50V, V_G=10V, L=20mH, R_g=25Ω

■ ELECTRICAL CHARACTERISTICS ($T_C=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain to Source Breakdown Voltage	V_{DSS}	$V_{GS}=0V, I_D=250\mu A$	650	-	-	V
Drain to Source Leakage Current	I_{DSS}	$V_{DS}=650V, V_{GS}=0V$	-	-	1	μA
Gate to Source Forward Leakage	$I_{GSS(F)}$	$V_{DS}=0V, V_{GS}=+30V$	-	-	100	nA
Gate to Source Reverse Leakage	$I_{GSS(R)}$	$V_{DS}=0V, V_{GS}=-30V$	-	-	-100	nA
On characteristics						
Drain to Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=7.5A$	-	0.27	0.3	Ω
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	-	4	V
Dynamic characteristics						
Gate Resistance	R_g	$V_{GS}=0V, V_{DS}=0V, f=1.0\text{MHz}$	-	7.2	-	Ω
Forward Transconductance	g_{fs}	$V_{DS}=10V, I_D=3A$	-	5	-	S
Input Capacitance	C_{iss}	$V_{DS}=40V, V_{GS}=0V$ $f=1.0\text{MHz}$	-	928	-	pF
Output Capacitance	C_{oss}		-	690	-	pF
Reverse Transfer Capacitance	C_{rss}		-	13	-	pF
Resistive Switching Characteristics						
Turn-on Delay Time	$t_{d(ON)}$	$I_D=7.5A, V_{DS}=520V$ $R_G=10\Omega, V_{GS}=10V$	-	20.2	-	ns
Rise Time	t_r		-	9.8	-	ns
Turn-off Delay Time	$t_{d(OFF)}$		-	73	-	ns
Fall Time	t_f		-	6.7	-	ns
Total Gate Charge	Q_g	$I_D=7.5A, V_{DS}=520V$ $V_{GS}=10V$	-	22	-	nC
Gate to Source Charge	Q_{gs}		-	4.6	-	nC
Gate to Drain("Miller") Charge	Q_{gd}		-	7.6	-	nC
Source-Drain Diode Characteristics						
Continuous Source Current(Body Diode)	I_S		-	-	15	A
Maximum Pulsed Current(Body Diode)	I_{SM}		-	-	60	A
Diode Forward Voltage	V_{SD}	$I_{SD}=1A, V_{GS}=0V$	-	0.74	1.2	V
Reverse Recovery Time	t_{rr}	$I_{SD}=7.5A, T_J=25^{\circ}\text{C}$	-	250	-	ns
Reverse Recovery Charge	Q_{rr}	$di/dt=100A/\mu s$	-	2900	-	nC

■ TYPICAL CHARACTERISTICS

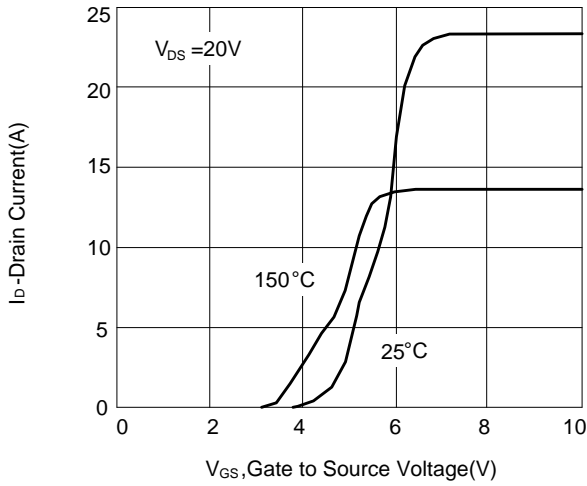


Figure 1: Transfer Characteristics

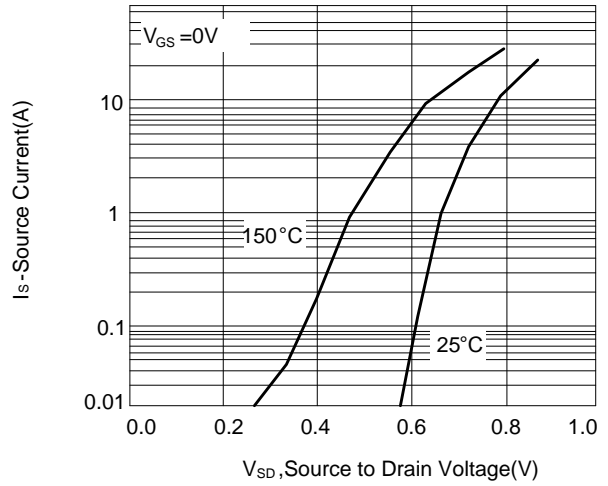


Figure 2: Body Diode Characteristics

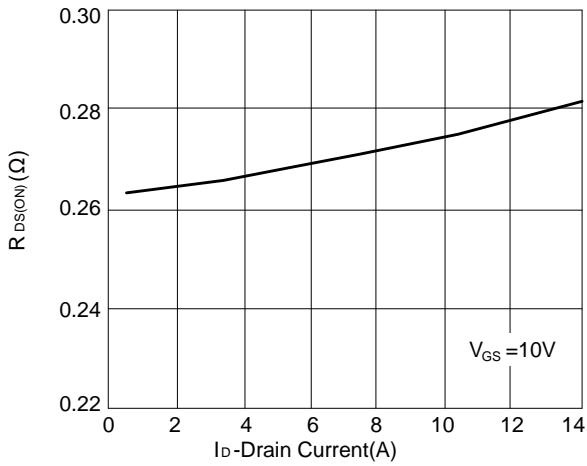


Figure 3: Drain to Source On-Resistance vs Drain Current

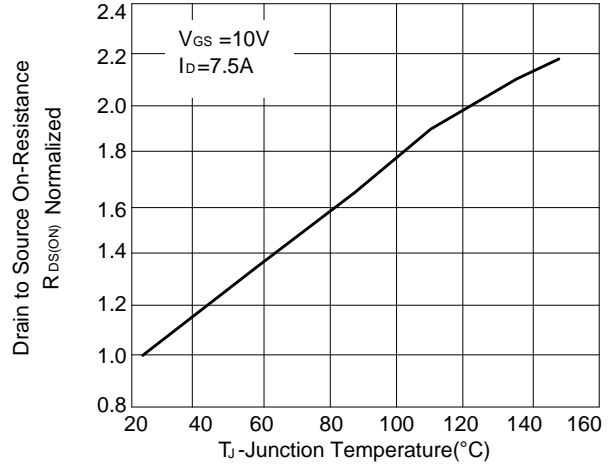


Figure 4: Drain to Source On-Resistance vs Junction Temperature

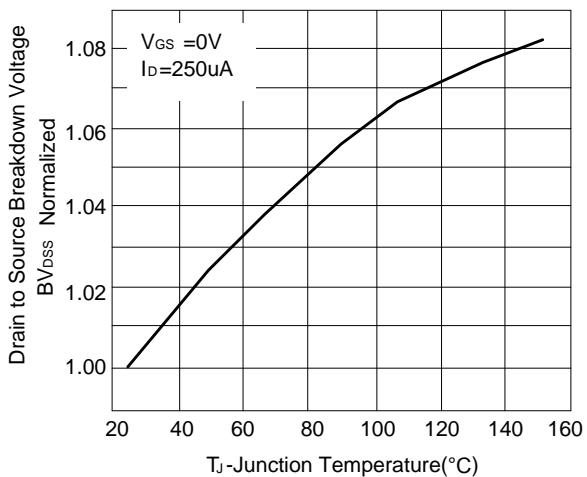


Figure 5: Breakdown Voltage vs Junction Temperature

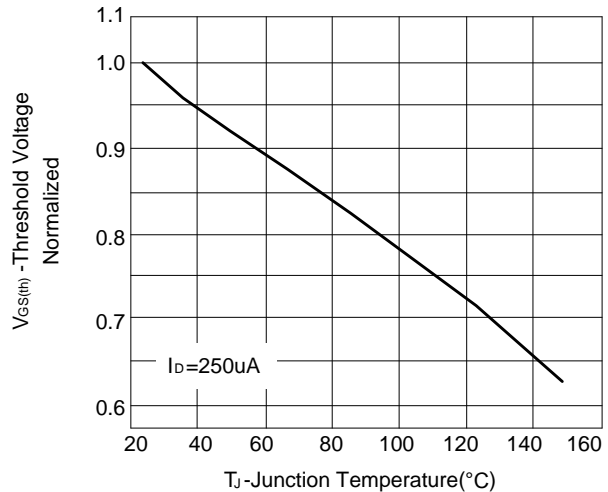


Figure 6: Threshold Voltage vs Junction Temperature

■ TYPICAL CHARACTERISTICS(Cont.)

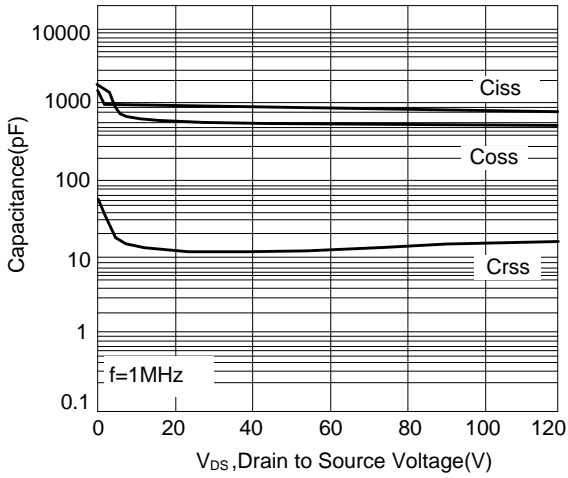


Figure 7: Capacitance vs Drain to Source Voltage

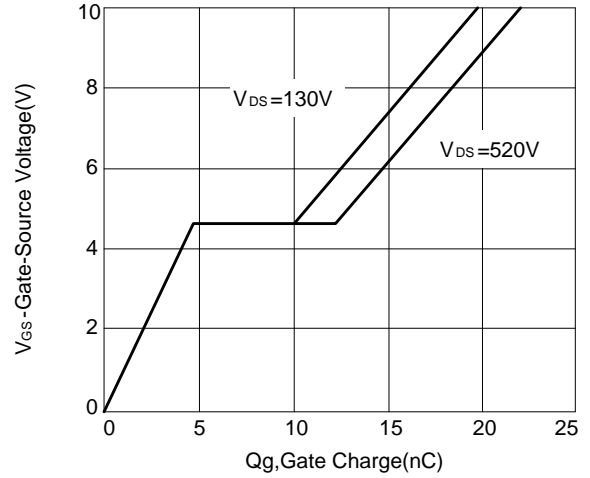


Figure 8: Gate Charge vs Gate to Source Voltage

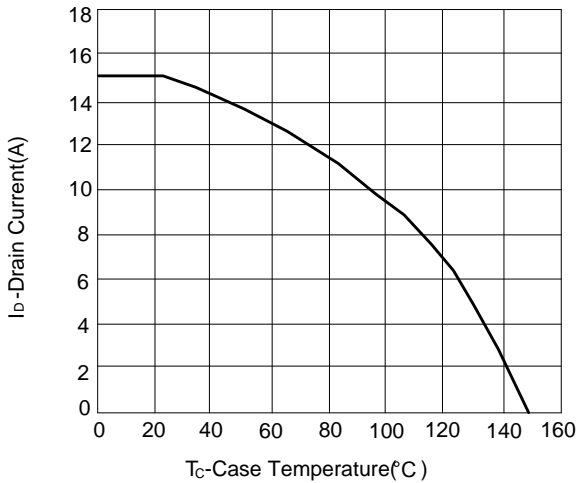


Figure 9: Continuous Drain vs Case Temperature

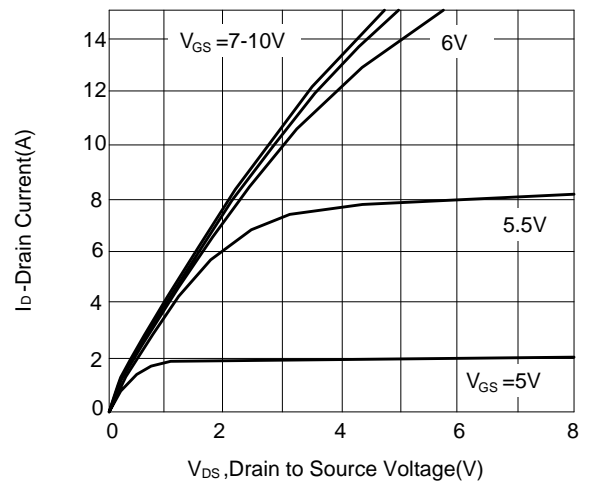


Figure 10: Output Characteristics

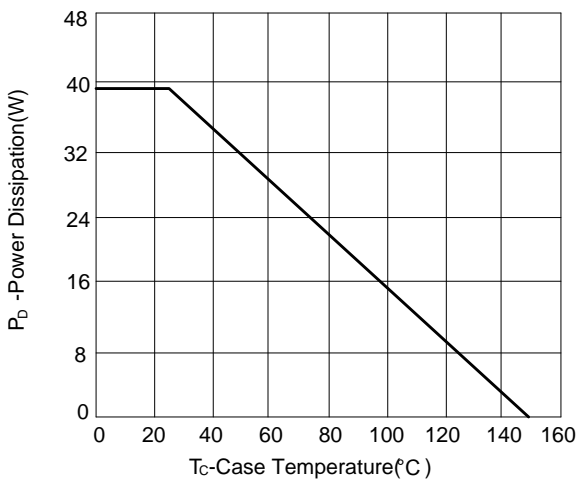


Figure 11: Power Dissipation vs Case Temperature

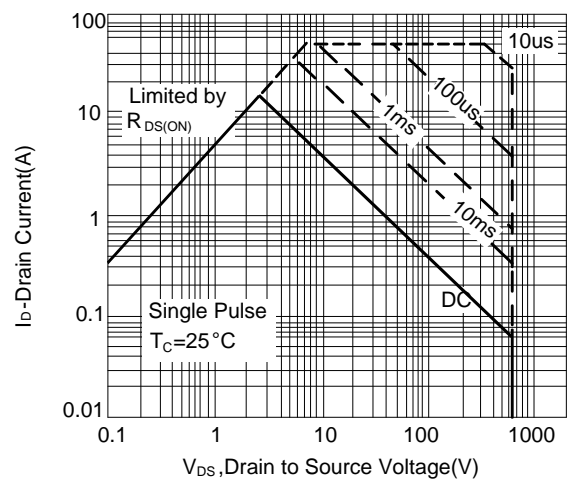


Figure 12: Safe operating Area

■ TO-220F PACKAGE OUTLINE DIMENSIONS

